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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/681,983	10/09/2003	Chun Ho Fan	50626.60	8846
35510 7590 06/15/2007 KEATING & BENNETT, LLP 8180 GREENSBORO DRIVE			EXAMINER	
		• •	ANDUJAR, LEONARDO	
SUITE 850 MCLEAN, VA	22102	•	ART UNIT	PAPER NUMBER
·		•	2826	
			NOTIFICATION DATE	DELIVERY MODE
			06/15/2007	ELECTRONIC

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

JKEATING@KBIPLAW.COM uspto@kbiplaw.com

	Application No.	Applicant(s)				
Office Action Summan	10/681,983	FAN ET AL.				
Office Action Summary	Examiner	Art Unit				
	Leonardo Andújar	2826				
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailine earned patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may a reply be tir by within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from the, cause the application to become ABANDONE	mely filed /s will be considered timely. I the mailing date of this communication. ED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed o	n <u>3/21/2007</u> .					
2a)⊠ This action is FINAL . 2b)☐ This	s action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 4	53 O.G. 213.				
Disposition of Claims						
4)⊠ Claim(s) <u>11-16</u> is/are pending in the applicatio	n.					
4a) Of the above claim(s) is/are withdra						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>11 and 16</u> is/are rejected.						
7)⊠ Claim(s) <u>15 and 16</u> is/are objected to.						
8) Claim(s) are subject to restriction and/o	or election requirement.					
Application Papers						
9) The specification is objected to by the Examine	er.					
10)⊠ The drawing(s) filed on 09 October 2003 is/are	: a)⊠ accepted or b)⊡ objected	I to by the Examiner.				
Applicant may not request that any objection to the	drawing(s) be held in abeyance. See	e 37 CFR 1.85(a).				
Replacement drawing sheet(s) including the correct	tion is required if the drawing(s) is ob	jected to. See 37 CFR 1.121(d).				
11) ☐ The oath or declaration is objected to by the Ex	kaminer. Note the attached Office	Action or form PTO-152.				
Priority under 35 U.S.C. § 119		·				
12) Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. § 119(a))-(d) or (f).				
a) ☐ All b) ☐ Some * c) ☐ None of:	a) ☐ All b) ☐ Some * c) ☐ None of:					
1. Certified copies of the priority documents have been received.						
Certified copies of the priority document	s have been received in Applicati	on No				
3. Copies of the certified copies of the prio	•	ed in this National Stage				
application from the International Burea	* **					
* See the attached detailed Office action for a list	of the certified copies not receive	≱d.				
Attach mont/ol						
Attachment(s) 1) Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail Da	ate				
 Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 	5) Notice of Informal P 6) Other:	Patent Application (PTO-152)				
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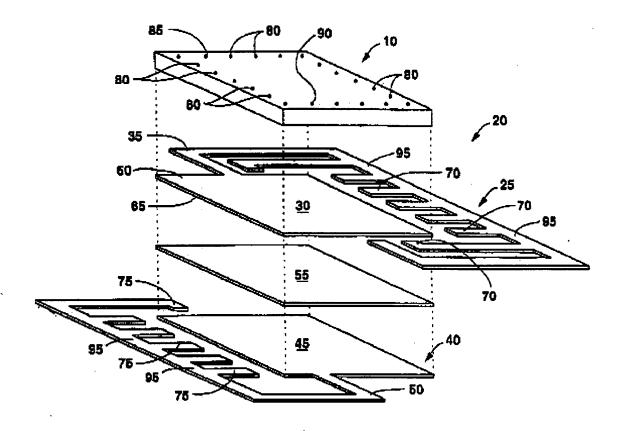
DETAILED ACTION

Claim Rejections - 35 USC § 103

1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

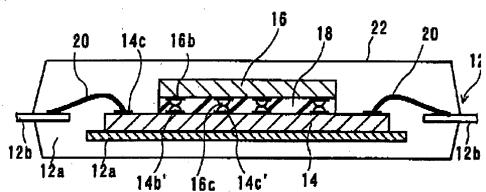
- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claim 11 is rejected under 35 U.S.C. 103(a) as being unpatentable over Stave (US 5,734,198) in view of Morifuji (US 6,175,157).
- 3. Regarding claim 11, Stave (e.g. fig. 1) shows a integrated circuit package comprising: a first lead frame 25; a second lead frame 40 laminated to a portion of a surface of the first lead frame (e.g. back) in order to create a multi layer lead frame; and a semiconductor 10 mounted to another portion of the surface of the first lead frame.

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Stave does not show a plurality of contacts balls mounted on the semiconductor die. However, Morifuji (e.g. 7) shows a semiconductor device 14 having a plurality of contact balls 14b' mounted on the semiconductor die. According to Morifuji, this type of embodiment increases the integration density while preventing the semiconductor chip from warping and from being damaged (col. 1/lls. 5-44).

FIG. 7



It would have been obvious to one of ordinary skill in the art at the time the invention was made to include contact balls on the semiconductor die disclosed by Stave in accordance with Morifuji's invention to increase the integration density while preventing the semiconductor chip from warping and from being damaged.

- 4. Claim 16 is rejected under 35 U.S.C. 103(a) as being unpatentable over Stave (US 5,734,198) in view of Morifuji (US 6,175,157) in view Takekawa et al. (US 4,714,952).
- 5. Regarding claim 16, Stave in view of Morifuji shows most aspects of the instant invention except for the semiconductor die coated with at least one of titanium, tungsten, gold or a combination thereof for soldering. However, Takekawa discloses that a semiconductor die can be coated with gold to stabilize the potential to be produced at the lower surface of the substrate (col. 10/lls. 52-57). It would have been obvious to one of ordinary skill in the art at the time the invention was made to coat the bottom surface of the semiconductor die disclosed by Stave in view of Morifuji with gold

in order to stabilize the potential to be produced at the lower surface of the substrate as taught by Takekawa.

Allowable Subject Matter

- Claims 12 and 15 are allowed. 6.
- 7. Claims 13 and 14 objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Response to Arguments

8. Applicant's arguments with respect to claims 11 and 16 have been considered but are not persuasive. Applicant agues that the prior art does not show a second leadframe laminated to a portion of a surface of said first lead frame thereby providing a multi-layer laminated lead frame; a semiconductor die mounted to another portion of said surface of said first leadframe. However, Stave (e.g. fig. 1) clearly discloses a first lead frame 25, a second lead frame 40 laminated to a portion of a surface of the first lead frame (e.g. back) forming a multi layer lead frame. Also, the semiconductor 10 is mounted in another portion of the surface of the first lead frame. In response to applicant's argument that the references fail to show certain features of applicant's invention, it is noted that the features upon which applicant relies (i.e., a semiconductor die mounted to the same side of the first leadframe) is not recited in the rejected claim(s). Although the claims are interpreted in light of the specification, limitations from the specification are not read into the claims. See In re Van Geuns, 988 F.2d 1181, 26 USPQ2d 1057 (Fed. Cir. 1993.) The claim recites "same surface". It is respectfully Application/Control Number: 10/681,983 Page 6

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noted that term surface is more generic that side. The limitation surface includes any variation of the term surface such as external surface, upper surface, lower surface, side surface, etc. In this case both are in the same surface (i.e. external surface of 30).

Conclusion

9. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

- 10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Leonardo Andújar whose telephone number is 571-272-1912. The examiner can normally be reached on Mon through Thu from 9:00 AM to 7:30 PM EST.
- 11. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sue Purvis can be reached on 571-272-1236. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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12. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information

system, call 800-786-9199 (IN USA OR CANADA) or 571-272,1000.

Neonardo Andejar Primary Examiner Art Unit 2826

06/06/2007